

Preface

2014 International Conference of Electronic Engineering and Information Science (ICEEIS 2014) will be held 21-22 June in Harbin, China. The ICEEIS 2014 is sponsored by Harbin University of Science and Technology.

The main role of ICEEIS 2014 is to bring together innovators from engineering researchers, scientists, practitioners to provide a forum to discuss ideas, concepts, and experimental results related to all aspects of electronic engineering and information science. In order to meet high standard of TTP, Advanced Materials Research, the organization committee has made their efforts to do the following things. Firstly, poor quality papers have been refused after reviewing course by anonymous referee experts. Secondly, periodically review meetings have been held around the reviewers about six times for exchanging reviewing suggestions. Finally, the conference organization had several preliminary sessions before the conference. Through efforts of different people and departments, the conference will be successful and fruitful.

ICEEIS 2014 is co-sponsored by Harbin University. In addition, the conference organizer will invite some keynote speakers to deliver their speech in the conference. All participants will have chance to discuss with the speakers face to face, which is very helpful for participants.

We hope that you will enjoy the conference and find the ICEEIS 2014 exciting. We are looking forward to seeing more friends at the next conference.

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